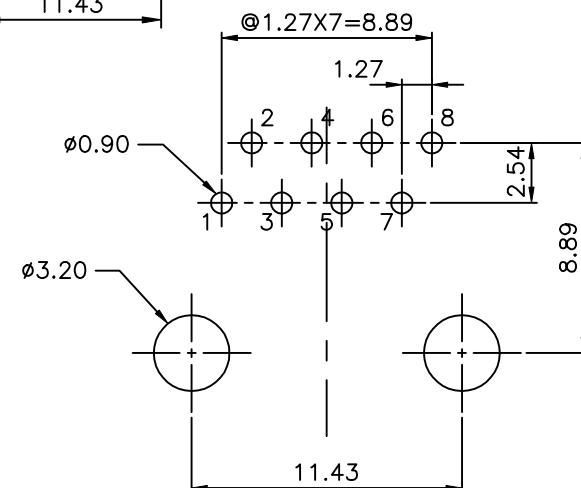
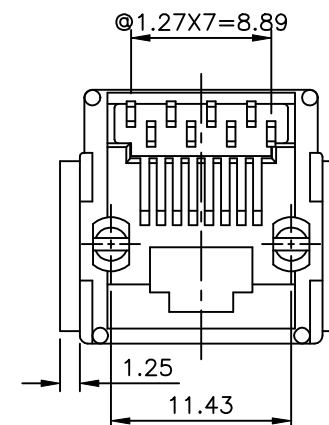
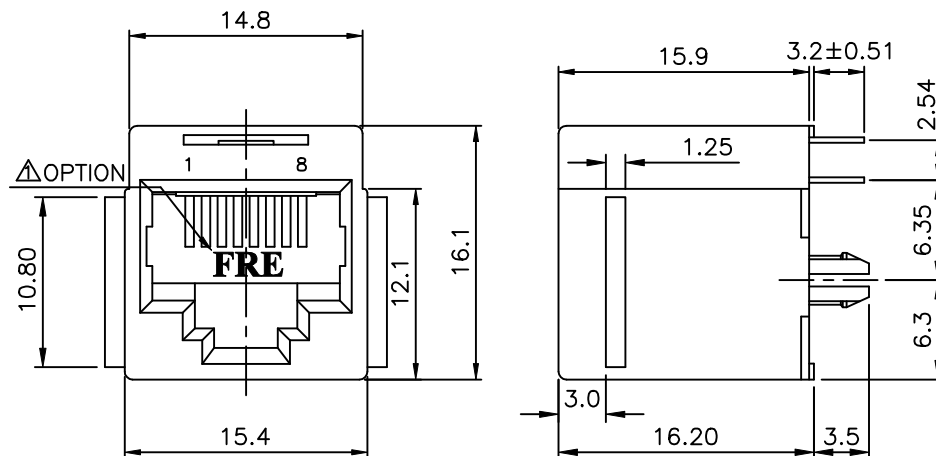


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		ADD PART NUMBER OPTION	Christ 5/15/01*	
△		NOTES MODIFY	Among 11/01/04	



PC Board Layout Component Side Shown

NOTES:**ELECTRICAL:**

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
- △ 3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
 - △ 2. OPERATION: -40°C TO +85°C.
- MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E5288-X0003X

- △ 3-W/ FRE LOGO 1- 3u" 2- 6u"
R-W/O FRE LOGO 3-15u" 4-30u"
5-50u"

DETACHED LISTS TOLERANCES EXCEPT AS NOTED .0 ± 0.2 .00 ± 0.15 .000 ± 0.075 ANGLES ± 0.5 THIRD ANGLE PROJECTION		DFTO JACK CHKD SAMMY MFO APPVL USEHNG DATE 12/4/99* DATE 2004/11/17	FULL RISE ELECTRONIC CO., LTD TITLE RJ45 TOP ENTRY PCB MODULAR JACK(DIP TYPE)	
		MATERIAL : QT'Y : FINISH : SCALE :	DRAWING NO. GE523A20 /PART NO. SEE NOTE DO NOT SCALE DRAWING	
		SIZE A3	REV 11/01/04 2	SHEET X OF Y